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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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# HEF4538B-Q100

## Dual precision monostable multivibrator

Rev. 2 — 10 December 2013

Product data sheet

## 1. General description

The HEF4538B-Q100 is a dual retriggerable-resettable monostable multivibrator. Each multivibrator has an active LOW trigger/retrigger input ( $n\bar{A}$ ) and an active HIGH trigger/retrigger input ( $nB$ ). It has an overriding active LOW direct reset input ( $n\bar{CD}$ ) and an output ( $nQ$ ) together with its complement ( $n\bar{Q}$ ). There are also two pins for connecting the external timing components  $C_{ext}$  and  $R_{ext}$ . These pins,  $nREXT/CEXT$ , and  $nCEXT$ , are always connected to ground. Typical pulse width variation over the specified temperature range is  $\pm 0.2\%$ .

Either the positive or the negative edges of the input pulse can trigger the multivibrator. The trigger produces an accurate output pulse with a pulse width range of 10  $\mu\text{s}$  to infinity. The external timing components  $C_{ext}$  and  $R_{ext}$  determine the duration and accuracy of the output pulse. The output pulse width ( $t_W$ ) is equal to  $R_{ext} \times C_{ext}$ . The linear design techniques in LOC MOS (Local Oxide CMOS) guarantee precise control of the output pulse width. A LOW level at  $n\bar{CD}$  terminates the output pulse immediately. The Schmitt trigger action of the trigger inputs, makes the circuit highly tolerant of slower rise and fall times.

It operates over a recommended  $V_{DD}$  power supply range of 3 V to 15 V referenced to  $V_{SS}$  (usually ground). Unused inputs must be connected to  $V_{DD}$ ,  $V_{SS}$ , or another input.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

## 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - ◆ Specified from  $-40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$  and from  $-40\text{ }^\circ\text{C}$  to  $+125\text{ }^\circ\text{C}$
- Tolerant of slow trigger rise and fall times
- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- ESD protection:
  - ◆ MIL-STD-883, method 3015 exceeds 2000 V
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115-A exceeds 200 V ( $C = 200\text{ pF}$ ,  $R = 0\ \Omega$ )
- Complies with JEDEC standard JESD 13-B

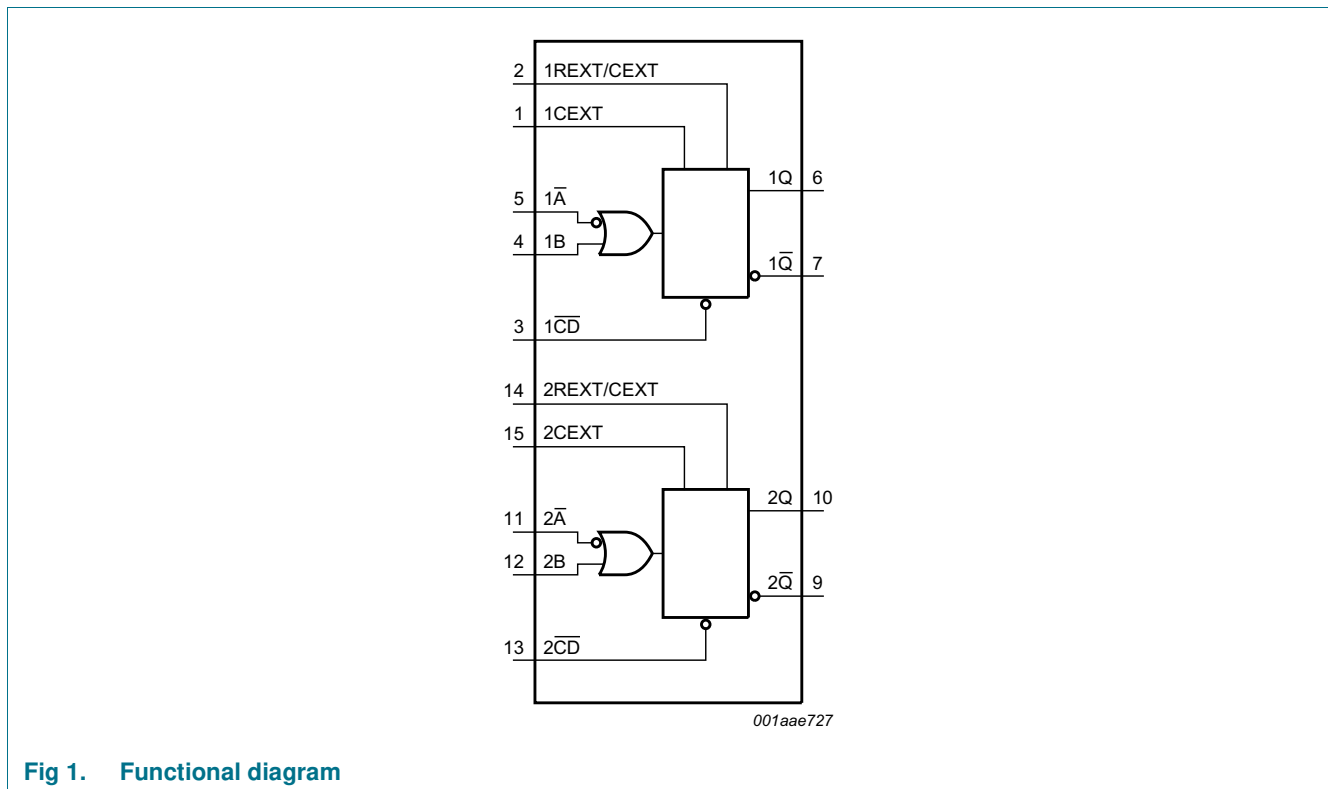


### 3. Ordering information

**Table 1. Ordering information**  
 All types operate from  $-40\text{ }^{\circ}\text{C}$  to  $+125\text{ }^{\circ}\text{C}$ .

Type number	Package		Version
	Name	Description	
HEF4538BT-Q100	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1

### 4. Functional diagram



**Fig 1. Functional diagram**

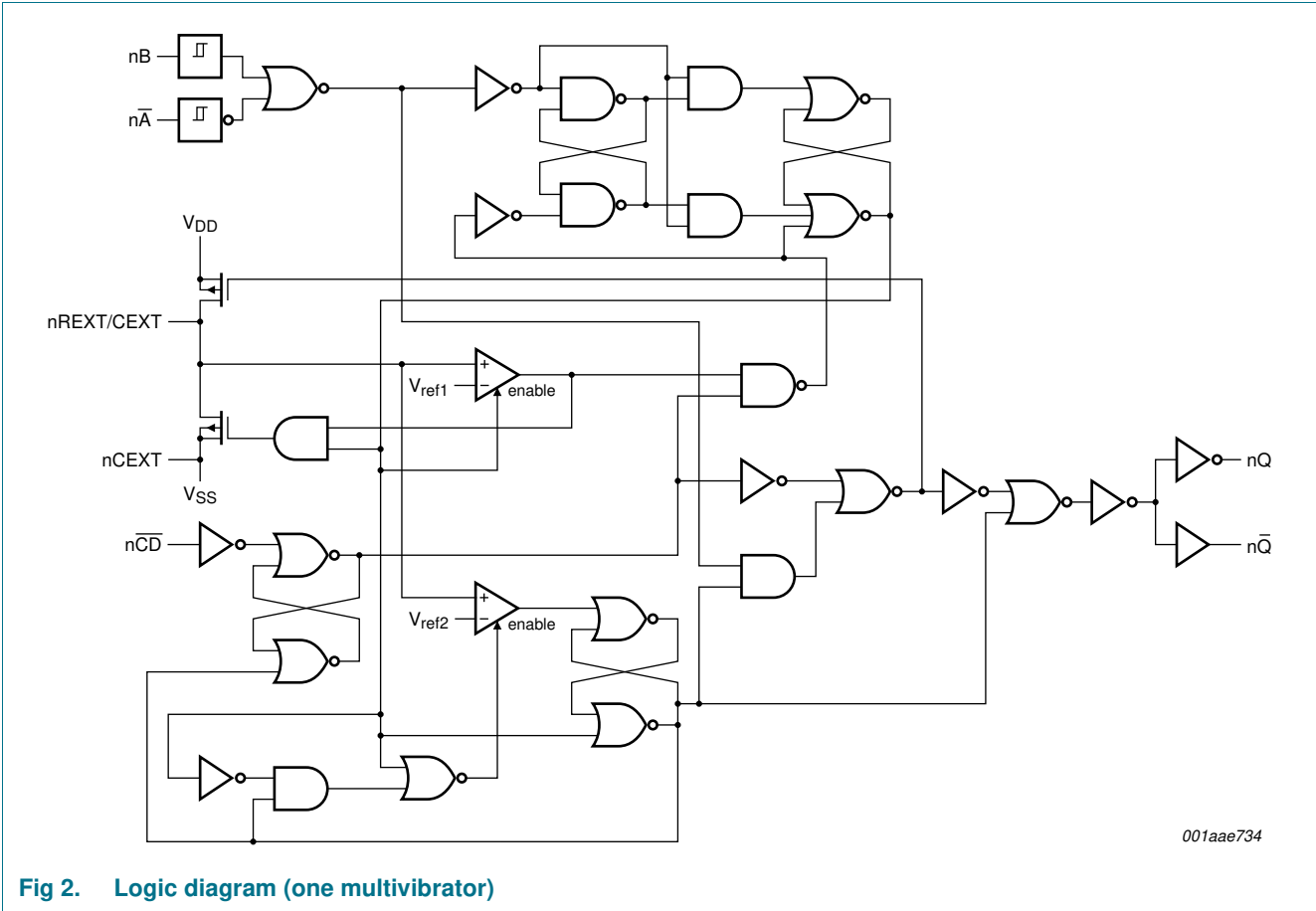


Fig 2. Logic diagram (one multivibrator)

## 5. Pinning information

### 5.1 Pinning

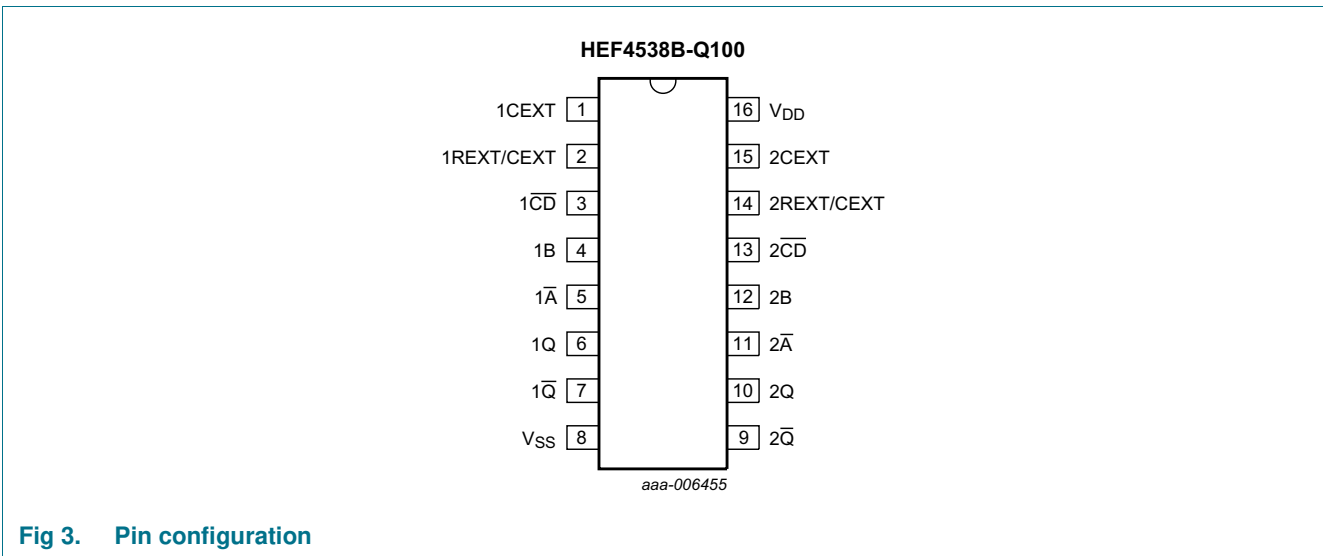


Fig 3. Pin configuration





## 5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1CEXT, 2CEXT	1, 15	external capacitor connection (always connected to ground)
1REXT/CEXT, 2REXT/CEXT	2, 14	external capacitor/resistor connection
1 $\overline{CD}$ , 2 $\overline{CD}$	3, 13	direct reset input (active LOW)
1B, 2B	4, 12	input (LOW-to-HIGH triggered)
1 $\overline{A}$ , 2 $\overline{A}$	5, 11	input (HIGH-to-LOW triggered)
1Q, 2Q	6, 10	output
1 $\overline{Q}$ , 2 $\overline{Q}$	7, 9	complementary output (active LOW)
V <sub>SS</sub>	8	ground supply voltage
V <sub>DD</sub>	16	supply voltage


## 6. Functional description


Table 3. Function table

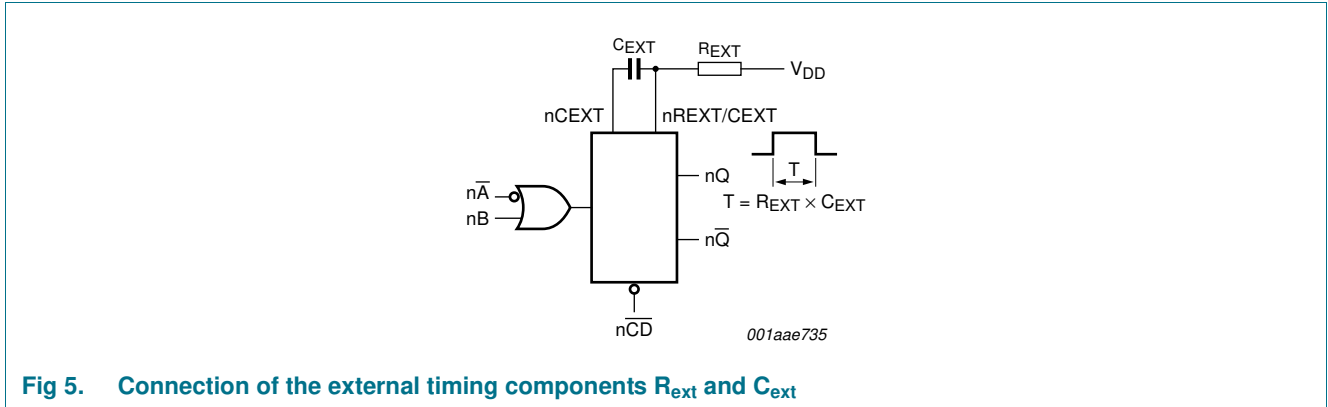
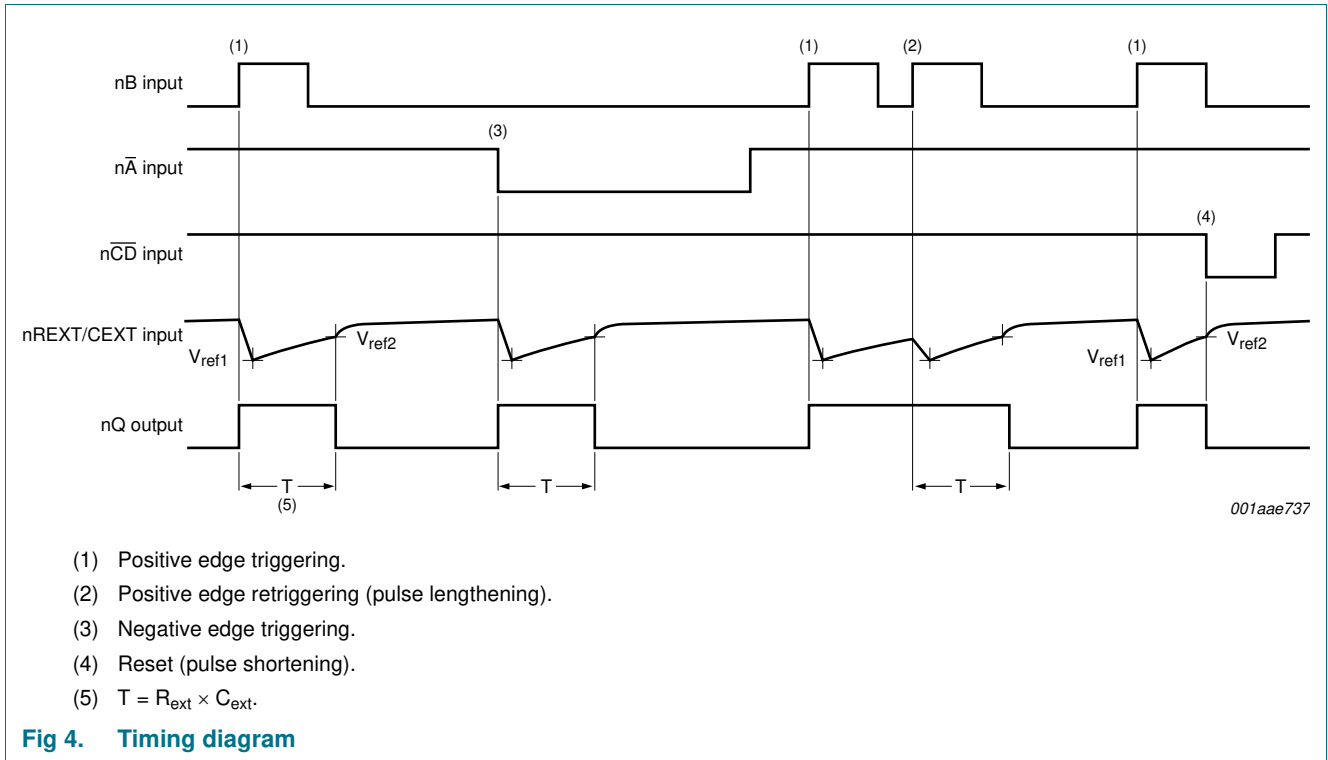
Inputs			Outputs	
n $\overline{A}$	nB	n $\overline{CD}$	nQ	n $\overline{Q}$
↓	L	H		
H	↑	H		
X	X	L	L	H

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care;

↑ = positive-going transition; ↓ = negative-going transition;

 = one HIGH level output pulse, with the pulse width determined by C<sub>ext</sub> and R<sub>ext</sub>;

 = one LOW level output pulse, with the pulse width determined by C<sub>ext</sub> and R<sub>ext</sub>.



## 7. Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to  $V_{SS} = 0\text{ V}$  (ground)

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DD}$	supply voltage		-0.5	+18	V
$I_{IK}$	input clamping current	$V_I < -0.5\text{ V}$ or $V_I > V_{DD} + 0.5\text{ V}$	-	$\pm 10$	mA
$V_I$	input voltage		-0.5	$V_{DD} + 0.5$	V
$I_{OK}$	output clamping current	$V_I < -0.5\text{ V}$ or $V_I > V_{DD} + 0.5\text{ V}$	-	$\pm 10$	mA
$I_{I/O}$	input/output current		-	$\pm 10$	mA
$I_{DD}$	supply current		-	50	mA
$T_{stg}$	storage temperature		-65	+150	$^{\circ}\text{C}$

**Table 4. Limiting values ...continued**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to  $V_{SS} = 0$  V (ground)

Symbol	Parameter	Conditions	Min	Max	Unit
$T_{amb}$	ambient temperature		-40	+125	°C
$P_{tot}$	total power dissipation	$T_{amb} = -40$ °C to +125 °C	[1] -	500	mW
P	power dissipation	per output	-	100	mW

[1] For SO16 package:  $P_{tot}$  derates linearly with 8 mW/K above 70 °C.

## 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{DD}$	supply voltage		3	-	15	V
$V_I$	input voltage		0	-	$V_{DD}$	V
$T_{amb}$	ambient temperature	in free air	-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{DD} = 5$ V	-	-	3.75	µs/V
		$V_{DD} = 10$ V	-	-	0.5	µs/V
		$V_{DD} = 15$ V	-	-	0.08	µs/V

## 9. Static characteristics

**Table 6. Static characteristics**

$V_{SS} = 0$  V;  $V_I = V_{SS}$  or  $V_{DD}$  unless otherwise specified.

Symbol	Parameter	Conditions	$V_{DD}$	$T_{amb} = -40$ °C		$T_{amb} = 25$ °C		$T_{amb} = 85$ °C		$T_{amb} = 125$ °C		Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
$V_{IH}$	HIGH-level input voltage	$ I_O  < 1$ µA	5 V	3.5	-	3.5	-	3.5	-	3.5	-	V
			10 V	7.0	-	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	11.0	-	V
$V_{IL}$	LOW-level input voltage	$ I_O  < 1$ µA	5 V	-	1.5	-	1.5	-	1.5	-	1.5	V
			10 V	-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	-	4.0	V
$V_{OH}$	HIGH-level output voltage	$ I_O  < 1$ µA	5 V	4.95	-	4.95	-	4.95	-	4.95	-	V
			10 V	9.95	-	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	14.95	-	V
$V_{OL}$	LOW-level output voltage	$ I_O  < 1$ µA	5 V	-	0.05	-	0.05	-	0.05	-	0.05	V
			10 V	-	0.05	-	0.05	-	0.05	-	0.05	V
			15 V	-	0.05	-	0.05	-	0.05	-	0.05	V
$I_{OH}$	HIGH-level output current	$V_O = 2.5$ V	5 V	-	-1.7	-	-1.4	-	-1.1	-	-1.1	mA
		$V_O = 4.6$ V	5 V	-	-0.64	-	-0.5	-	-0.36	-	-0.36	mA
		$V_O = 9.5$ V	10 V	-	-1.6	-	-1.3	-	-0.9	-	-0.9	mA
		$V_O = 13.5$ V	15 V	-	-4.2	-	-3.4	-	-2.4	-	-2.4	mA



**Table 6. Static characteristics ...continued**  
 $V_{SS} = 0\text{ V}$ ;  $V_I = V_{SS}$  or  $V_{DD}$  unless otherwise specified.

Symbol	Parameter	Conditions	$V_{DD}$	$T_{amb} = -40\text{ }^\circ\text{C}$		$T_{amb} = 25\text{ }^\circ\text{C}$		$T_{amb} = 85\text{ }^\circ\text{C}$		$T_{amb} = 125\text{ }^\circ\text{C}$		Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
$I_{OL}$	LOW-level output current	$V_O = 0.4\text{ V}$	5 V	0.64	-	0.5	-	0.36	-	0.36	-	mA
		$V_O = 0.5\text{ V}$	10 V	1.6	-	1.3	-	0.9	-	0.9	-	mA
		$V_O = 1.5\text{ V}$	15 V	4.2	-	3.4	-	2.4	-	2.4	-	mA
$I_I$	input leakage current	$n\bar{A}$ , nB	15 V	-	$\pm 0.1$	-	$\pm 0.1$	-	$\pm 1.0$	-	$\pm 1.0$	$\mu\text{A}$
		nREXT/CEXT	15 V	-	$\pm 0.3$	-	$\pm 0.1$	-	$\pm 1.0$	-	$\pm 1.0$	$\mu\text{A}$
$C_I$	input capacitance		-	-	-	-	7.5	-	-	-	-	pF

**Table 7. Typical static characteristics**  
 $V_{SS} = 0\text{ V}$ ;  $V_I = V_{SS}$  or  $V_{DD}$ ;  $T_{amb} = +25\text{ }^\circ\text{C}$ .

Symbol	Parameter	Conditions	$V_{DD}$	Typ	Unit
$I_{DD}$	supply current	active state	5 V	[1]	$\mu\text{A}$
			10 V	150	$\mu\text{A}$
			15 V	220	$\mu\text{A}$
$C_I$	input capacitance	nREXT/CEXT	-	15	pF

[1] Only one monostable is switching: for the specified current during the output pulse (output nQ is HIGH).

## 10. Dynamic characteristics

**Table 8. Dynamic characteristics**  
 $V_{SS} = 0\text{ V}$ ;  $T_{amb} = 25\text{ }^\circ\text{C}$ ; for test circuit see [Figure 11](#).

Symbol	Parameter	Conditions	$V_{DD}$	Extrapolation formula[1]	Min	Typ	Max	Unit
$t_{PHL}$	HIGH to LOW propagation delay	$n\bar{A}$ , nB to $n\bar{Q}$ ; see <a href="#">Figure 6</a>	5 V	$193\text{ ns} + (0.55\text{ ns/pF}) C_L$	-	220	440	ns
			10 V	$74\text{ ns} + (0.23\text{ ns/pF}) C_L$	-	85	190	ns
			15 V	$52\text{ ns} + (0.16\text{ ns/pF}) C_L$	-	60	120	ns
		$n\bar{CD}$ to $n\bar{Q}$ ; see <a href="#">Figure 6</a>	5 V	$98\text{ ns} + (0.55\text{ ns/pF}) C_L$	-	125	250	ns
			10 V	$44\text{ ns} + (0.23\text{ ns/pF}) C_L$	-	55	110	ns
			15 V	$32\text{ ns} + (0.16\text{ ns/pF}) C_L$	-	40	80	ns
$t_{PLH}$	LOW to HIGH propagation delay	$n\bar{A}$ , nB to $n\bar{Q}$ ; see <a href="#">Figure 6</a>	5 V	$173\text{ ns} + (0.55\text{ ns/pF}) C_L$	-	200	460	ns
			10 V	$79\text{ ns} + (0.23\text{ ns/pF}) C_L$	-	90	180	ns
			15 V	$52\text{ ns} + (0.16\text{ ns/pF}) C_L$	-	60	120	ns
		$n\bar{CD}$ to $n\bar{Q}$ ; see <a href="#">Figure 6</a>	5 V	$98\text{ ns} + (0.55\text{ ns/pF}) C_L$	-	125	250	ns
			10 V	$44\text{ ns} + (0.23\text{ ns/pF}) C_L$	-	55	110	ns
			15 V	$32\text{ ns} + (0.16\text{ ns/pF}) C_L$	-	40	80	ns
$t_t$	transition time	see <a href="#">Figure 6</a>	5 V	$10\text{ ns} + (1.00\text{ ns/pF}) C_L$	-	60	120	ns
			10 V	$9\text{ ns} + (0.42\text{ ns/pF}) C_L$	-	30	60	ns
			15 V	$6\text{ ns} + (0.28\text{ ns/pF}) C_L$	-	20	40	ns
$t_{rec}$	recovery time	$n\bar{CD}$ to $n\bar{A}$ , nB; see <a href="#">Figure 7</a>	5 V	-	-	20	40	ns
			10 V	-	-	10	20	ns
			15 V	-	-	5	10	ns

**Table 8. Dynamic characteristics ...continued**  
 $V_{SS} = 0\text{ V}$ ;  $T_{amb} = 25\text{ }^{\circ}\text{C}$ ; for test circuit see [Figure 11](#).

Symbol	Parameter	Conditions	$V_{DD}$	Extrapolation formula <sup>[1]</sup>	Min	Typ	Max	Unit
$t_{trig}$	retrigger time	nQ, n $\bar{Q}$ to n $\bar{A}$ , nB; see <a href="#">Figure 7</a>	5 V		0	-	-	ns
			10 V		0	-	-	ns
			15 V		0	-	-	ns
$t_W$	pulse width	n $\bar{A}$ LOW; minimum width; see <a href="#">Figure 7</a>	5 V		90	45	-	ns
			10 V		30	15	-	ns
			15 V		24	12	-	ns
		nB HIGH; minimum width; see <a href="#">Figure 7</a>	5 V		50	25	-	ns
			10 V		24	12	-	ns
			15 V		20	10	-	ns
		n $\bar{C}\bar{D}$ LOW; minimum width; see <a href="#">Figure 7</a>	5 V		55	25	-	ns
			10 V		25	12	-	ns
			15 V		20	10	-	ns
		nQ or n $\bar{Q}$ ; $R_{ext} = 100\text{ k}\Omega$ ; $C_{ext} = 2.0\text{ nF}$ ; see <a href="#">Figure 7</a>	5 V		218	230	242	$\mu\text{s}$
			10 V		213	224	235	$\mu\text{s}$
			15 V		211	223	234	$\mu\text{s}$
		nQ or n $\bar{Q}$ ; $R_{ext} = 100\text{ k}\Omega$ ; $C_{ext} = 0.1\text{ }\mu\text{F}$ ; see <a href="#">Figure 7</a>	5 V		10.3	10.8	11.3	ms
			10 V		10.2	10.7	11.2	ms
			15 V		10.1	10.6	11.1	ms
nQ or n $\bar{Q}$ ; $R_{ext} = 100\text{ k}\Omega$ ; $C_{ext} = 10\text{ }\mu\text{F}$ ; see <a href="#">Figure 7</a>	5 V		1.01	1.09	1.11	s		
	10 V		0.99	1.04	1.09	s		
	15 V		0.99	1.04	1.09	s		
$\Delta t_W$	pulse width variation	nQ or n $\bar{Q}$ variation over temperature range; see <a href="#">Figure 8</a>	5 V		-	$\pm 0.2$	-	%
			10 V		-	$\pm 0.2$	-	%
			15 V		-	$\pm 0.2$	-	%
		nQ or n $\bar{Q}$ variation over $V_{DD}$ voltage range 5 V to 15 V; see <a href="#">Figure 9</a>			-	$\pm 1.5$	-	%
$R_{ext}$	external resistance	nQ or n $\bar{Q}$ variation between monostables in the same device; $R_{ext} = 100\text{ k}\Omega$ ; $C_{ext} = 2\text{ nF}$ to $10\text{ }\mu\text{F}$	5 V		-	$\pm 1$	-	%
			10 V		-	$\pm 1$	-	%
			15 V		-	$\pm 1$	-	%
$C_{ext}$	external capacitance				2000	-	no limits	pF

[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown ( $C_L$  in pF).  
 [2] The maximum permissible resistance  $R_{ext}$ , which holds the specified accuracy of  $t_W$  (nQ, n $\bar{Q}$  output), depends on the leakage current of the capacitor  $C_{ext}$  and the leakage of the HEF4538B-Q100.

11. Waveforms

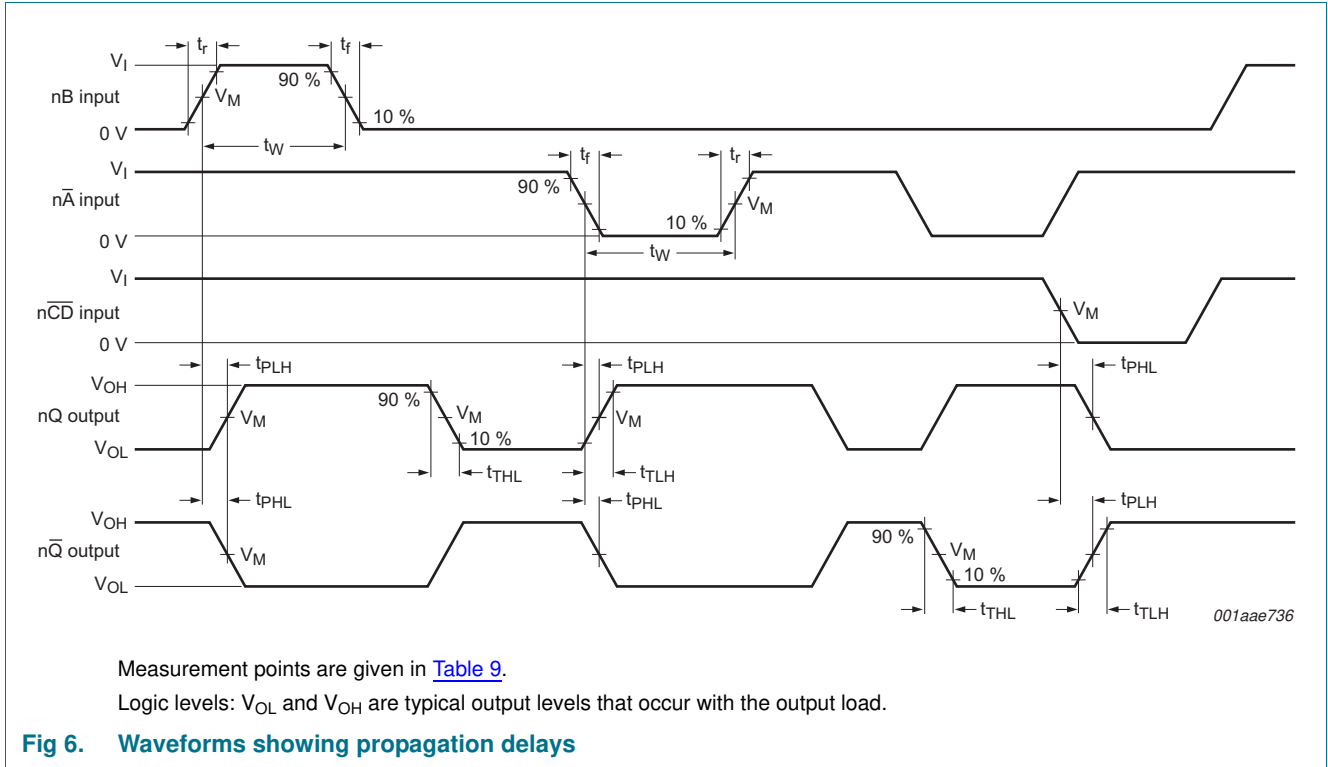
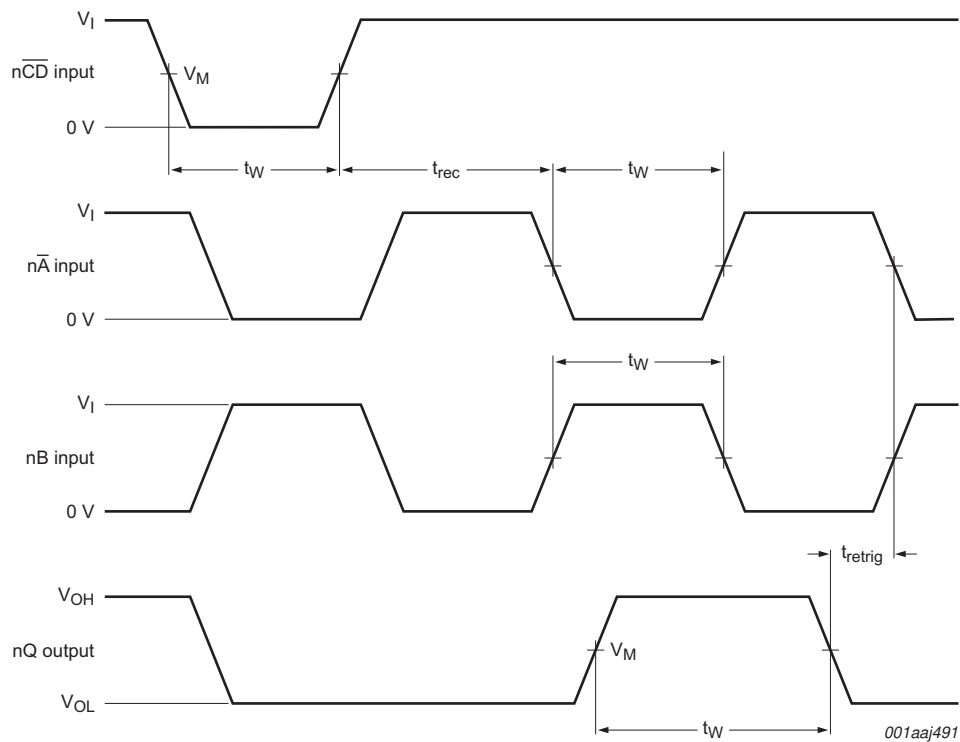


Table 9. Measurement points

Supply voltage	Input	Output
$V_{DD}$	$V_M$	$V_M$
5 V to 15 V	$0.5V_{DD}$	$0.5V_{DD}$

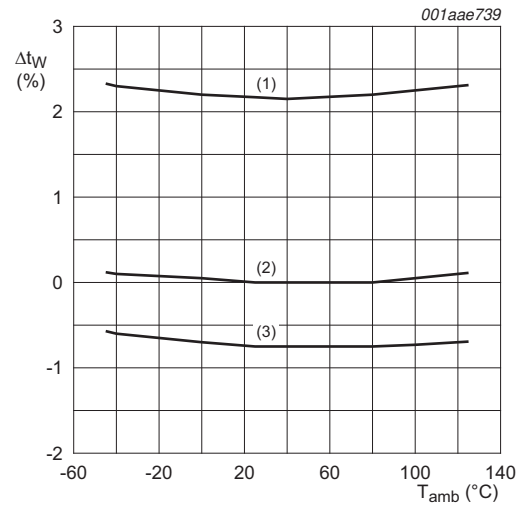
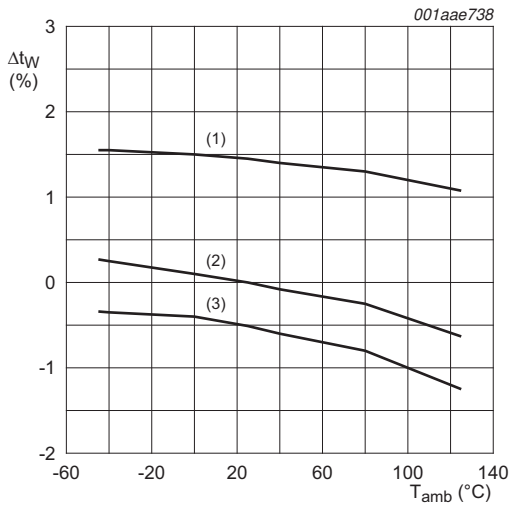


Measurement points are given in [Table 9](#).

Set-up and recovery times are shown as positive values but may be specified as negative values.

Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output levels that occur with the output load.

**Fig 7. Waveforms showing minimum  $n\overline{A}$ ,  $nB$ , and  $nQ$  pulse widths and set-up, recovery and retrigger times**



a.  $R_{ext} = 100\text{ k}\Omega$ ;  $C_{ext} = 100\text{ nF}$

b.  $R_{ext} = 100\text{ k}\Omega$ ;  $C_{ext} = 2\text{ nF}$

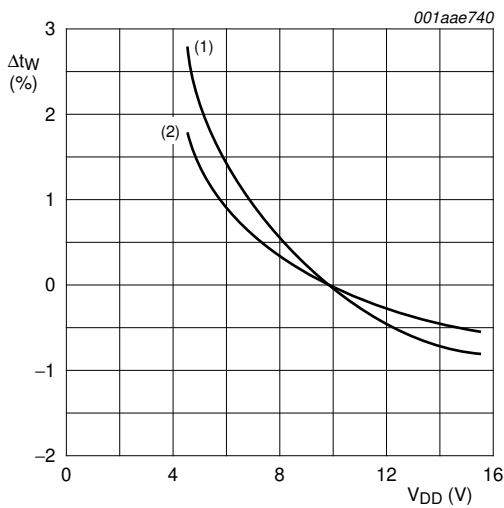
(1)  $V_{DD} = 5\text{ V}$ .

(2)  $V_{DD} = 10\text{ V}$ .

(3)  $V_{DD} = 15\text{ V}$ .

$\Delta t_W = 0\%$  at  $V_{DD} = 10\text{ V}$  and  $T_{amb} = 25\text{ }^\circ\text{C}$

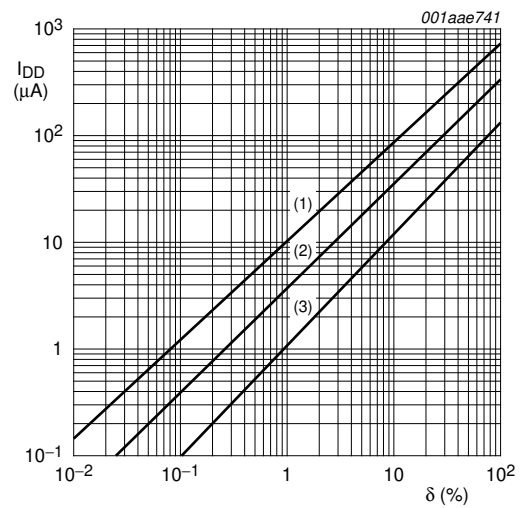
Fig 8. Typical normalized change in output pulse width as a function of ambient temperature



$T_{amb} = 25\text{ }^\circ\text{C}$ ;  $\Delta t_W = 0\%$  at  $V_{DD} = 10\text{ V}$ ;  $R_{ext} = 100\text{ k}\Omega$

(1)  $C_{ext} = 2\text{ nF}$ .

(2)  $C_{ext} = 100\text{ nF}$ .



$R_{ext} = 100\text{ k}\Omega$ ;  $C_{ext} = 100\text{ nF}$ ;  $C_L = 50\text{ pF}$ ;  
one monostable multivibrator switching only

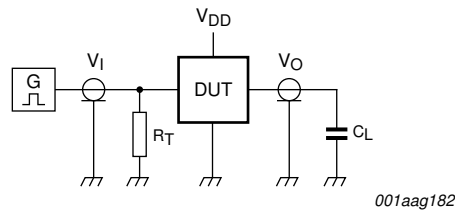
(1)  $V_{DD} = 15\text{ V}$ .

(2)  $V_{DD} = 10\text{ V}$ .

(3)  $V_{DD} = 5\text{ V}$ .

Fig 9. Typical normalized change in output pulse width as a function of the supply voltage

Fig 10. Total supply current as a function of the output duty factor



Test data is given in [Table 10](#).

Definitions for test circuit:

$C_L$  = load capacitance including jig and probe capacitance.

$R_T$  = termination resistance should be equal to the output impedance  $Z_o$  of the pulse generator.

**Fig 11. Test circuit**

**Table 10. Test data**

Supply voltage	Input		Load
$V_{DD}$	$V_I$	$t_r, t_f$	$C_L$
5 V to 15 V	$V_{SS}$ or $V_{DD}$	$\leq 20$ ns	50 pF

12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

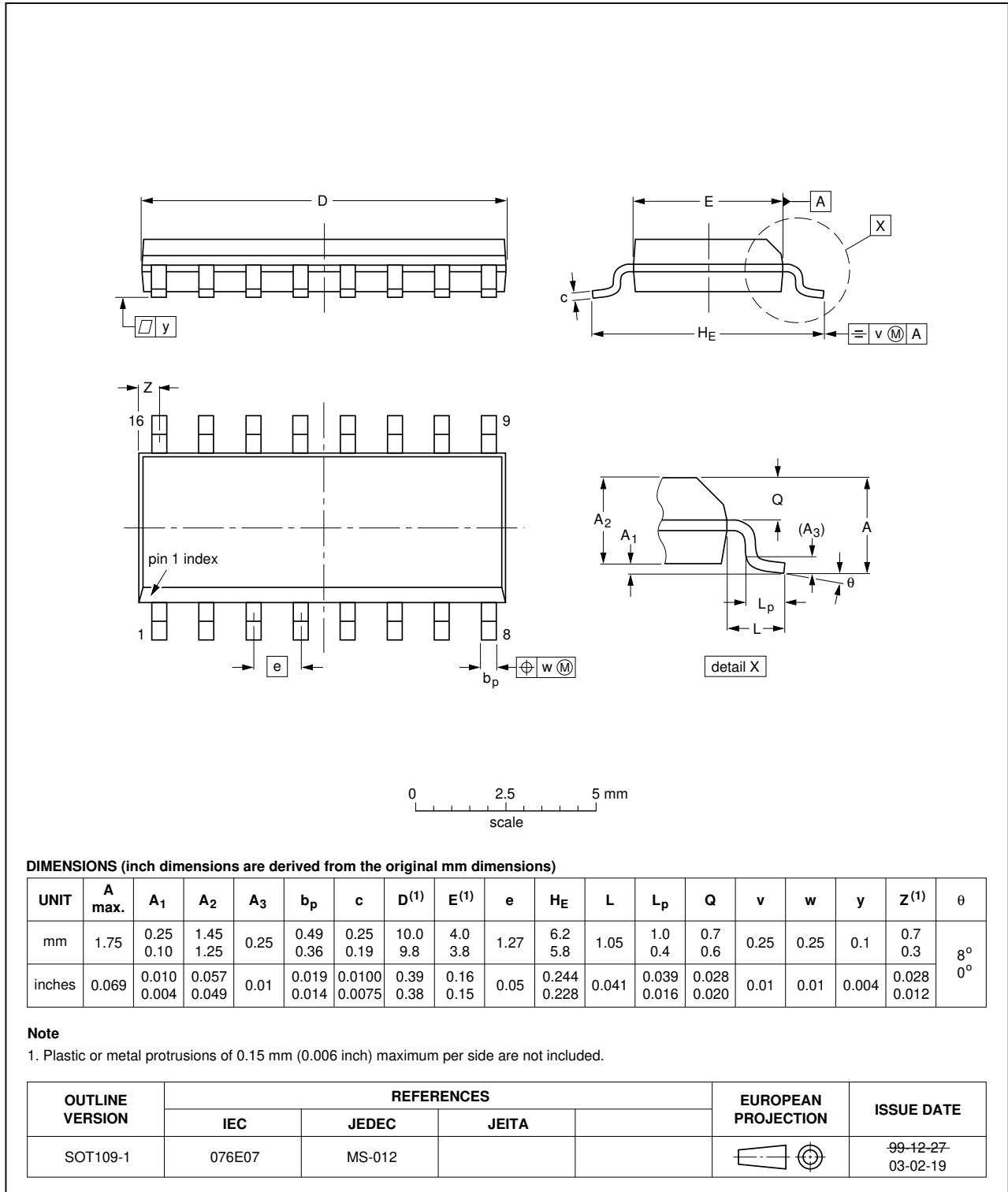


Fig 12. Package outline SOT109-1 (SO16)

## 13. Abbreviations

Table 11. Abbreviations

Acronym	Description
HBM	Human Body Model
ESD	ElectroStatic Discharge
MM	Machine Model
MIL	Military

## 14. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4538B_Q100 v.2	20131210	Product data sheet	-	HEF4538B_Q100 v.1
Modifications:	• <a href="#">Figure 8</a> and <a href="#">Figure 9</a> updated to show output pulse width over full temperature range.			
HEF4538B_Q100 v.1	20130228	Product data sheet	-	-



## 15. Legal information

### 15.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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**Date of release: 10 December 2013**  
**Document identifier: HEF4538B\_Q100**